### 502326407 04/26/2013

#### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Muneyuki FUKUDA	03/13/2009
Naomasa SUZUKI	03/18/2009
Tomoyasu SHOJO	03/13/2009
Noritsugu TAKAHASHI	03/13/2009

#### RECEIVING PARTY DATA

Name:	Hitachi High-Technologies Corporation	
Street Address:	1-24-14, Nishi Shinbashi, Minato-ku	
City:	Tokyo	
State/Country:	JAPAN	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13871624

#### CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	NITT-0523
NAME OF SUBMITTER:	Sheila M. Price
Signature:	/Sheila M. Price/
Date:	04/26/2013

Total Attachments: 1

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OP \$40,00

PATENT REEL: 030299 FRAME: 0065

## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan,

located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

# CHARGED PARTICLE BEAM APPARATUS PERMITTING HIGH-RESOLUTION AND HIGH-CONTRAST OBSERVATION

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi High-Technologies Corporation,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation.

Signed on the date(s) indicated aside our signatures:

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Muneyari Furuda Muneyuki FUKUDA	3/13/2007
	Naonasa Saguhi Naonasa SUZUKI	3/18/2009
3)	Tomoyasu SHOJO	3/13/2009
4)	Noritsugu Takahashi Noritsugu TAKAHASHI	3/13/2009

PATENT REEL: 030299 FRAME: 0066

**RECORDED: 04/26/2013**